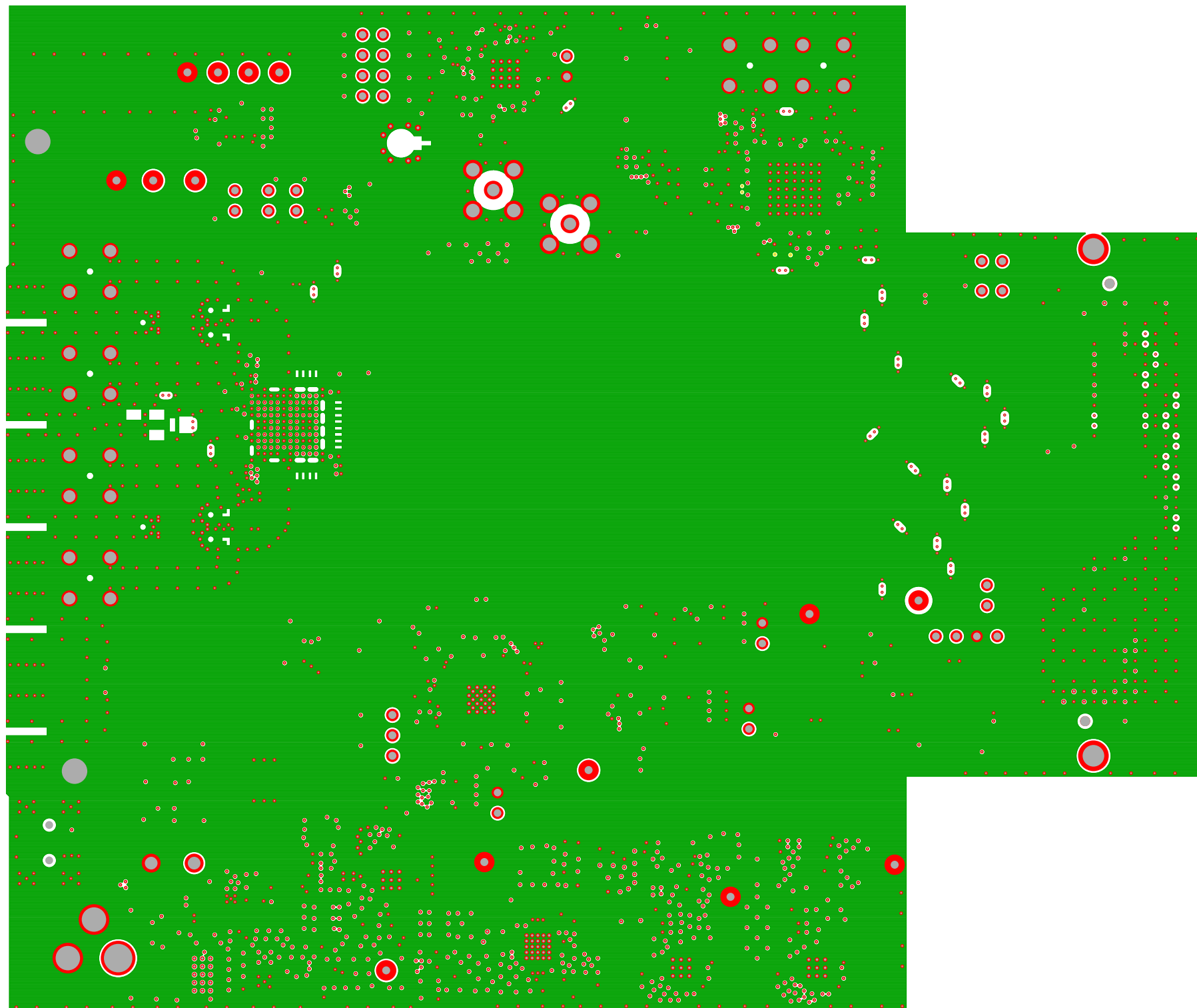


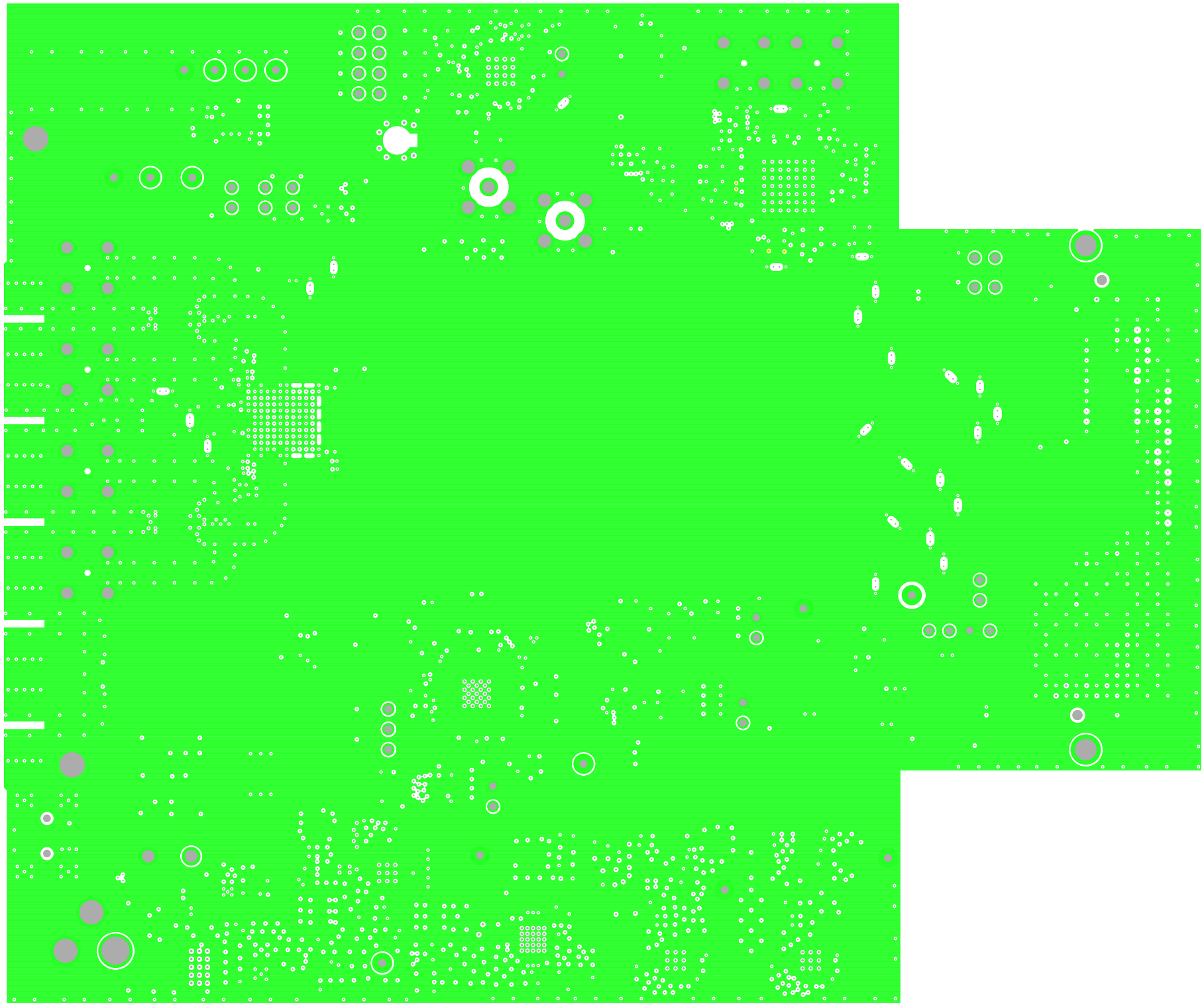
TEXAS INSTRUMENTS, INC.
ADCXXDJXX00EVM REV A
HSP-001

LAYER 1 (TOP SIDE)



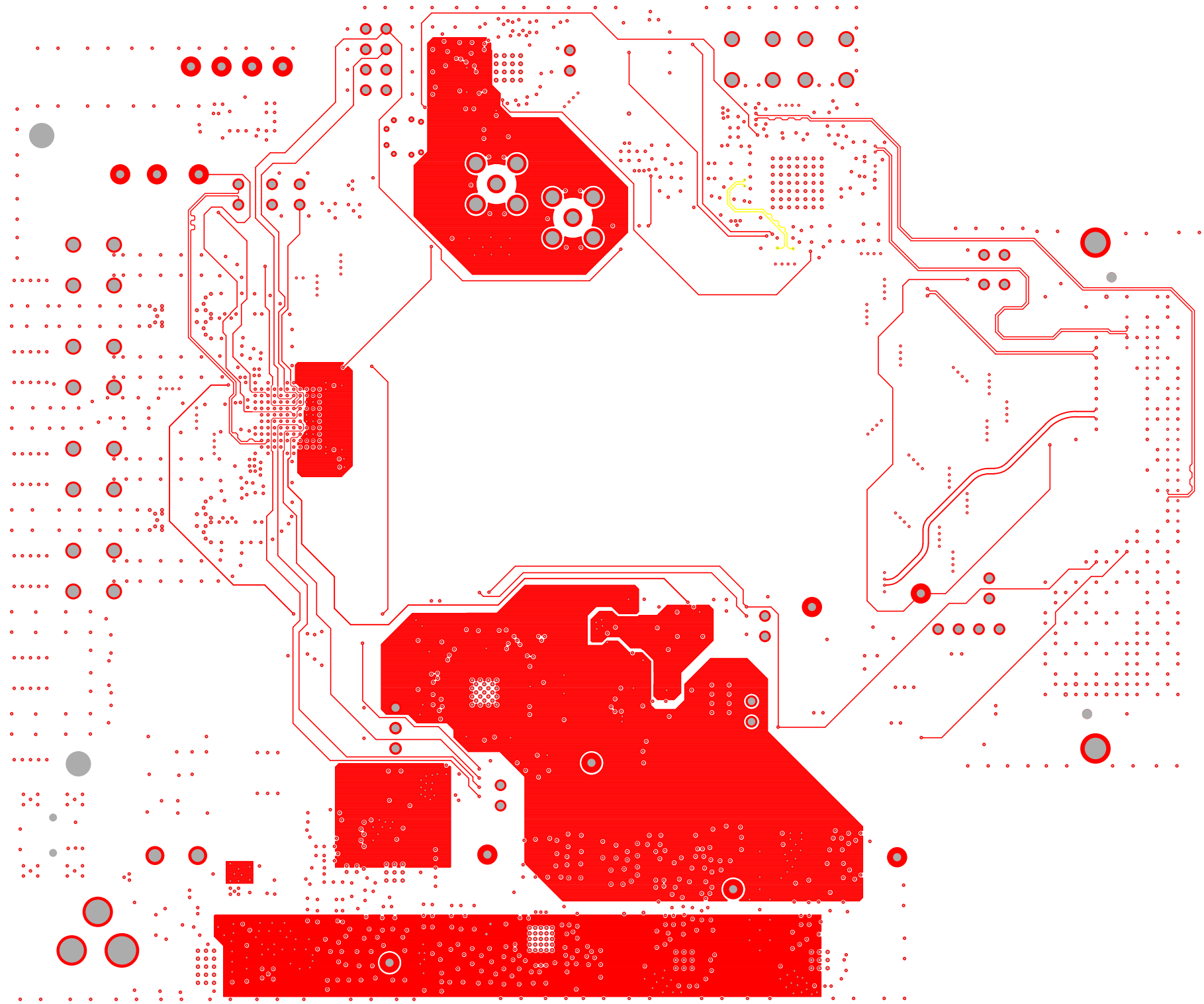
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 2 - GND



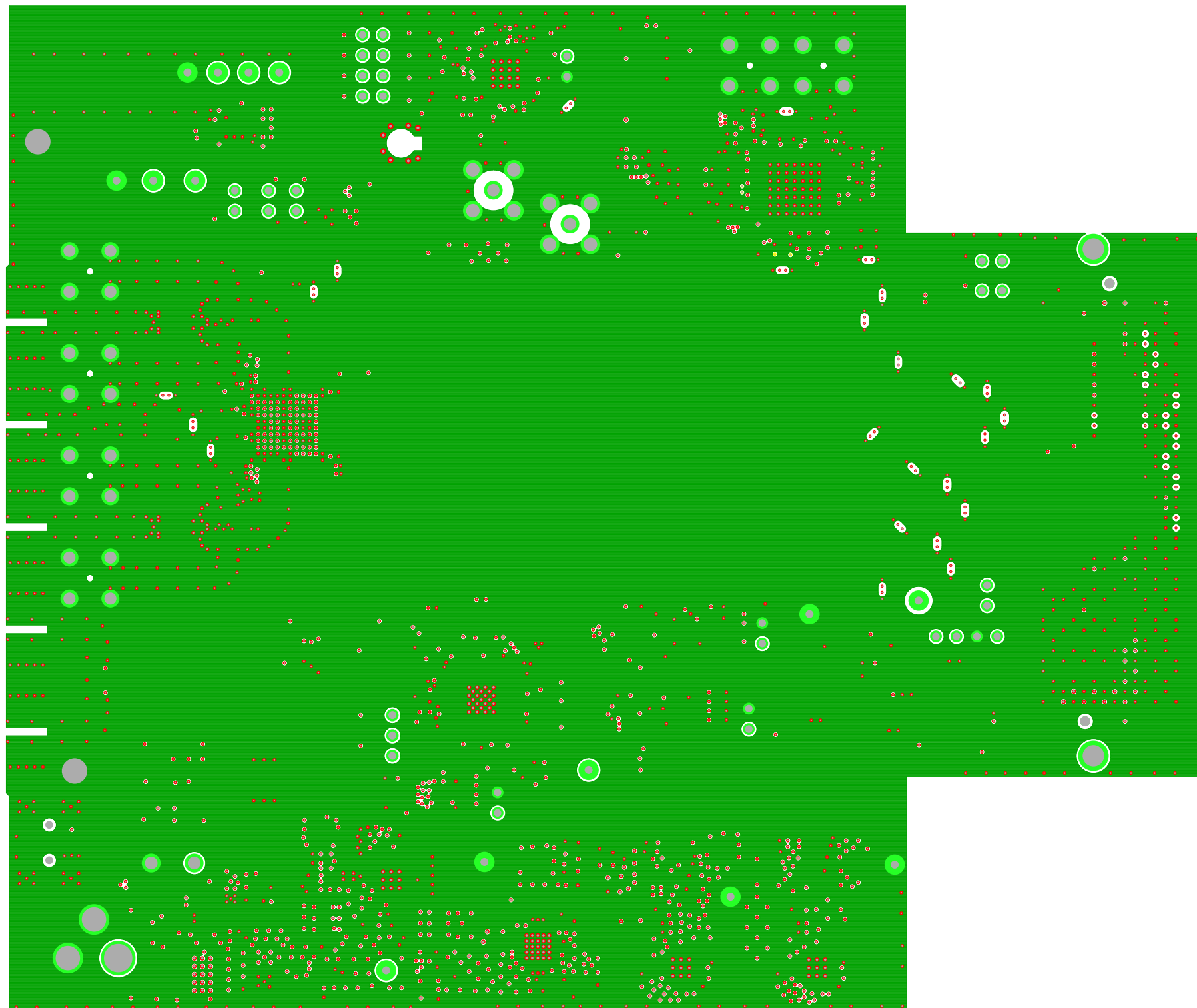
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 3 - GND



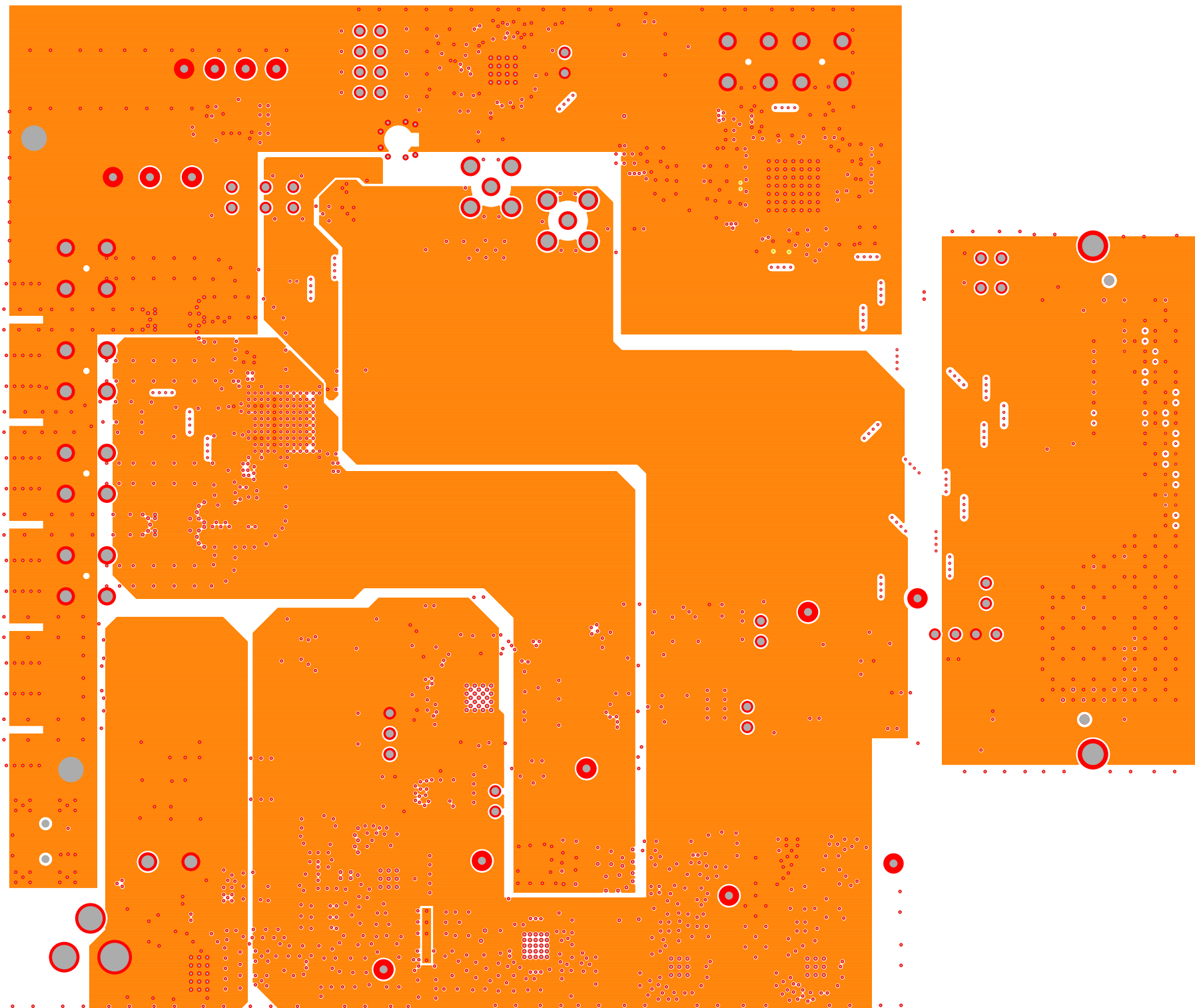
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ADCXDJXX00EVM REV A
HSP-001

LAYER 4 - SIG-1



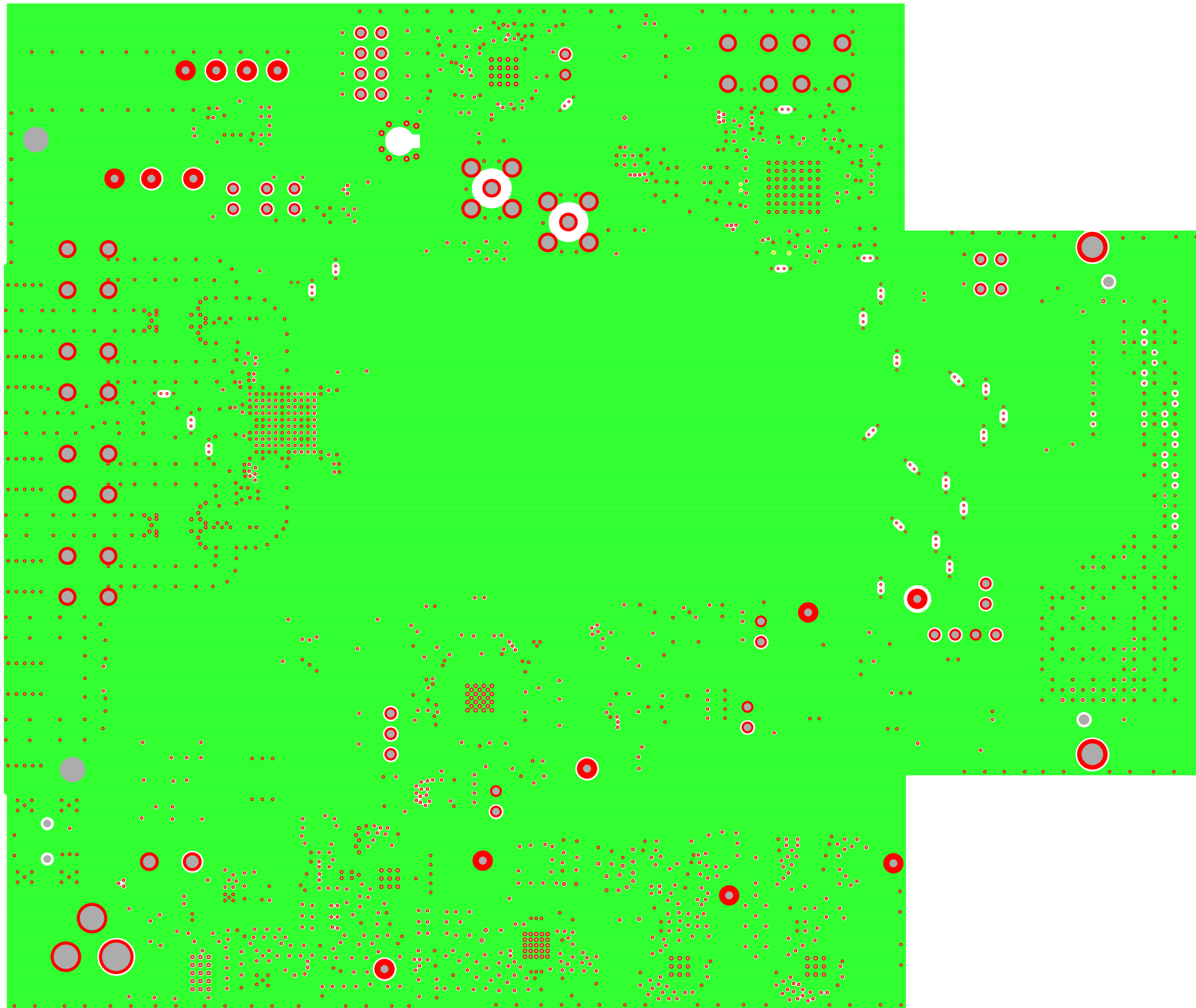
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HSP-001

LAYER 5 - GND



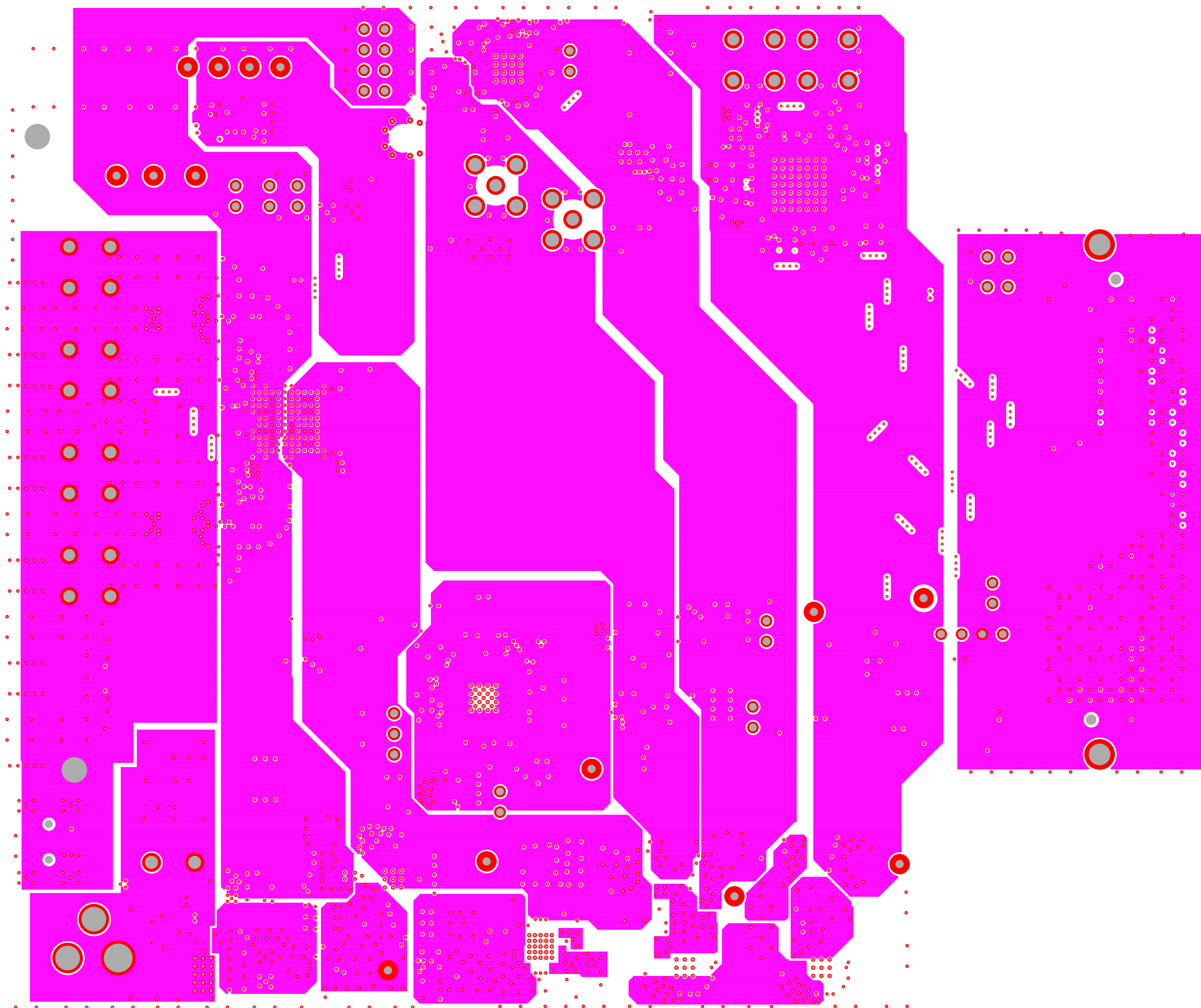
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 5 - PWR-1



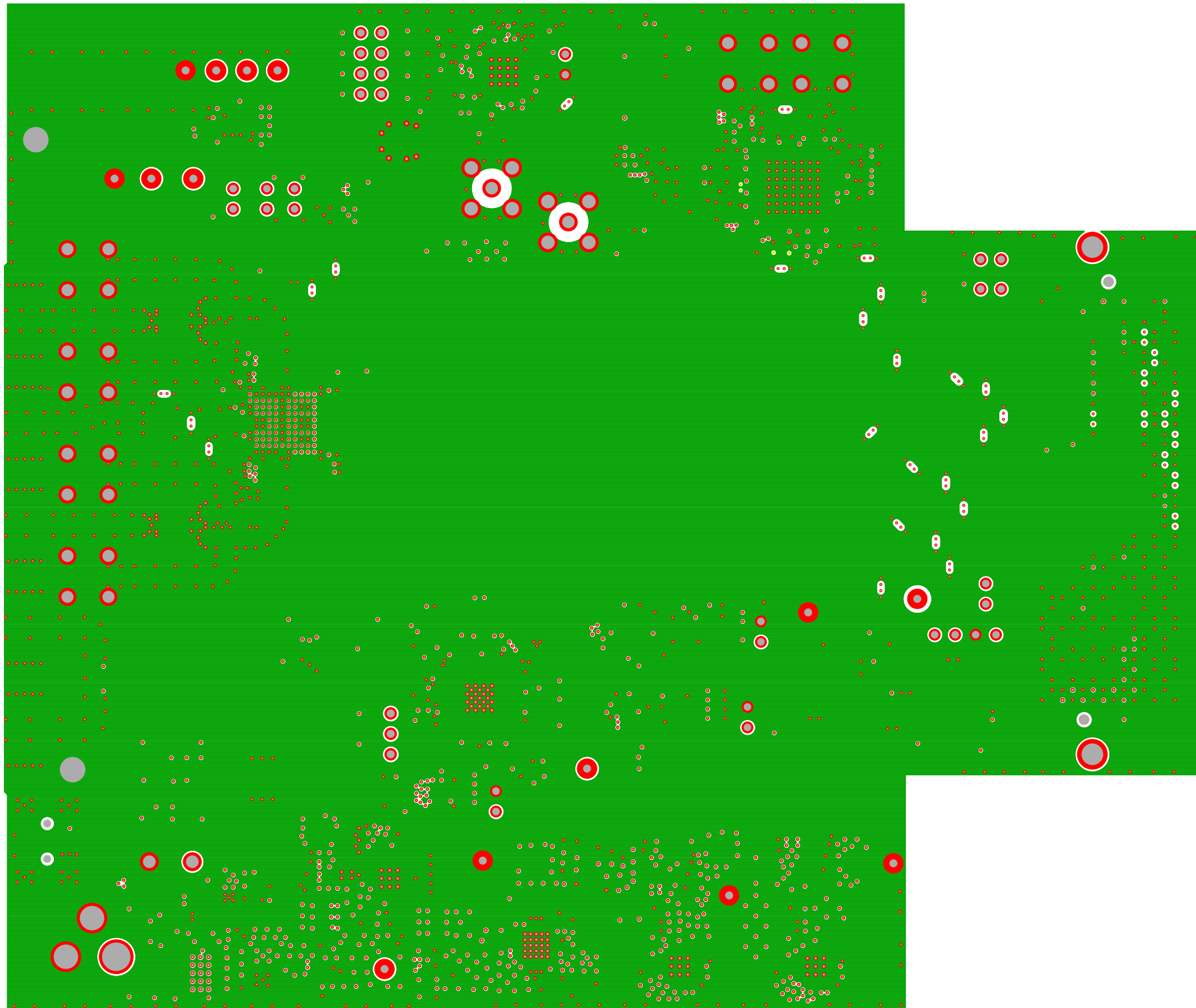
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 7 - GND



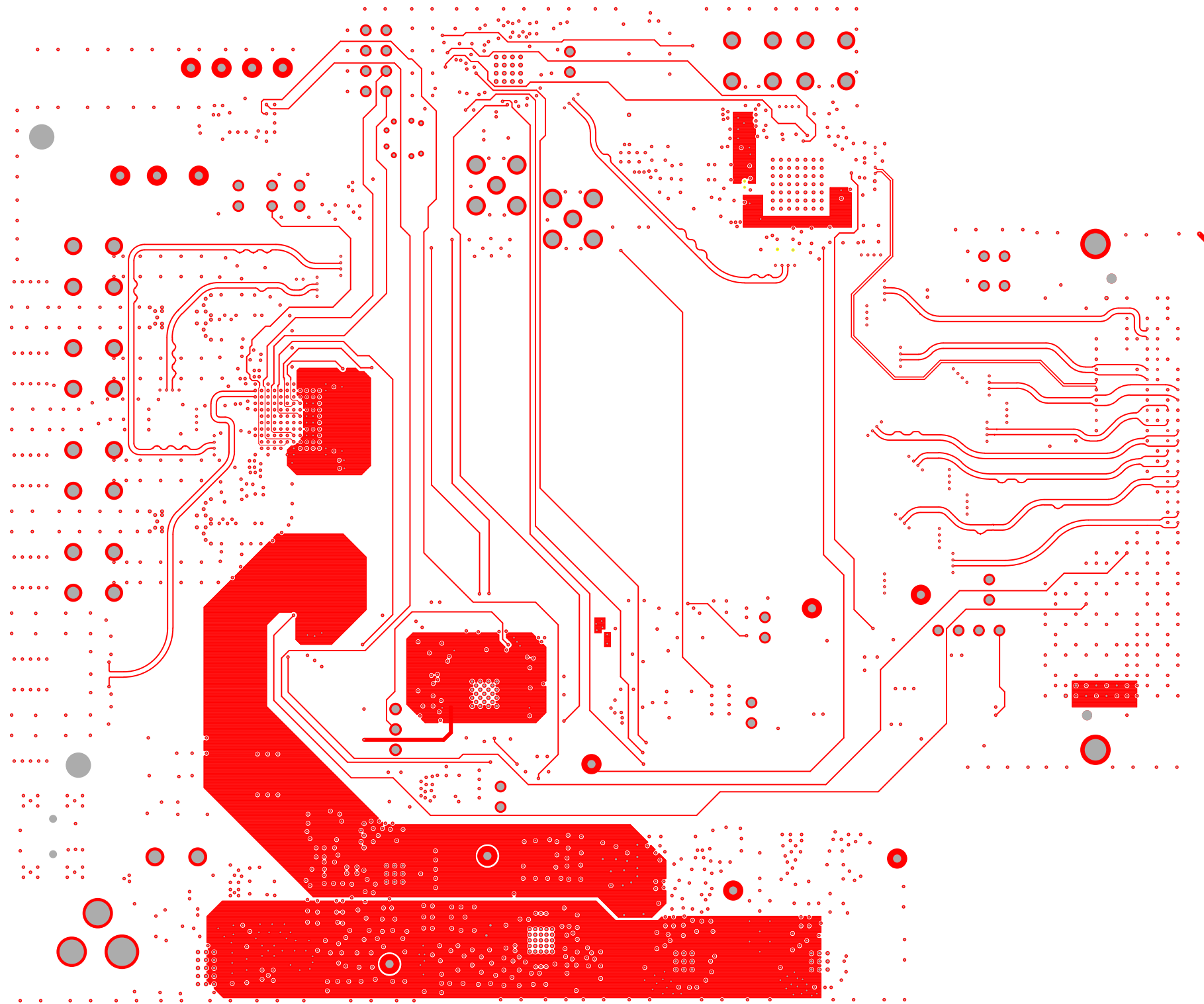
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ADCXDJXX00EVM REV A
HSP-001

LAYER 8 - PWR-2



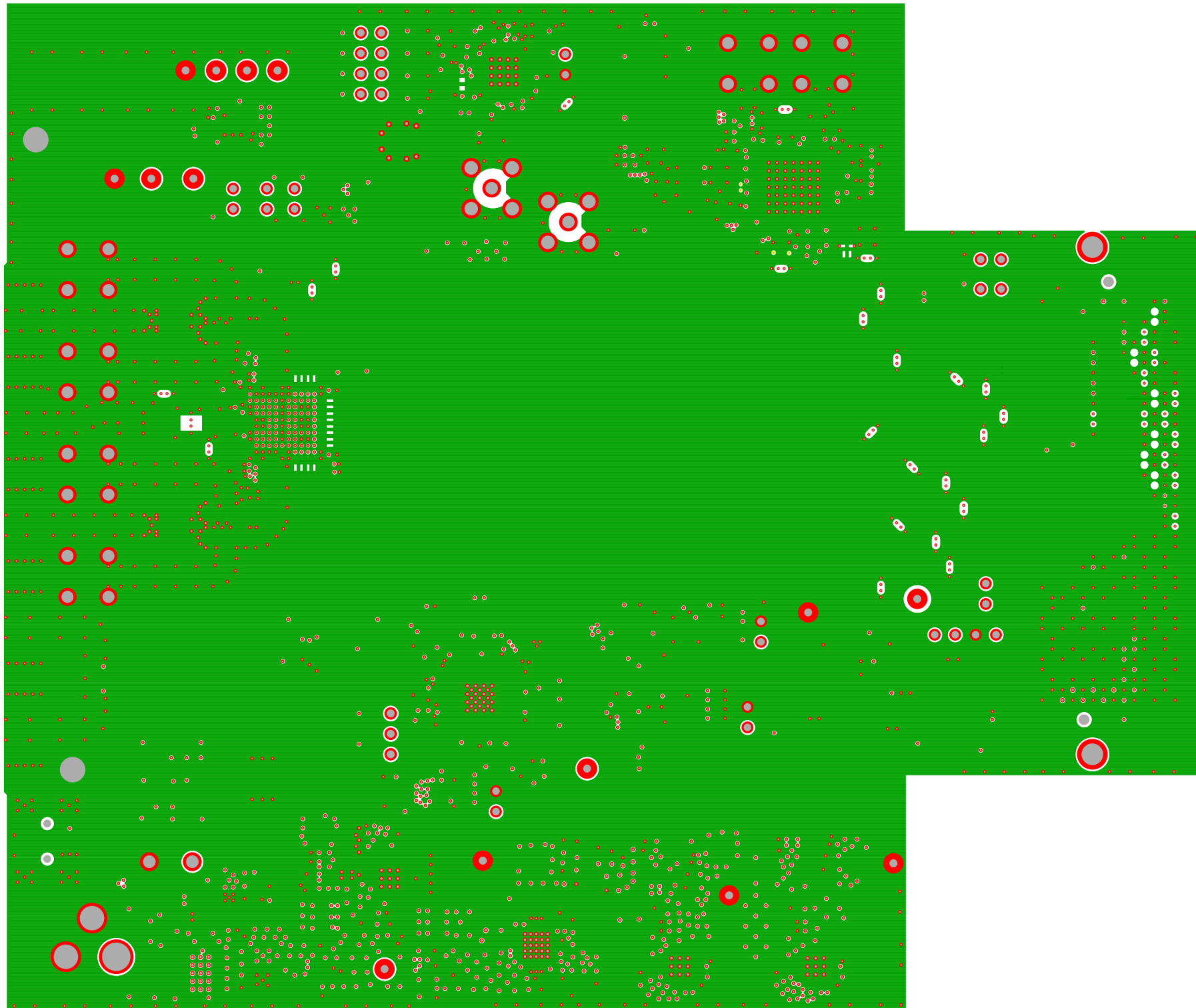
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 9 - GND



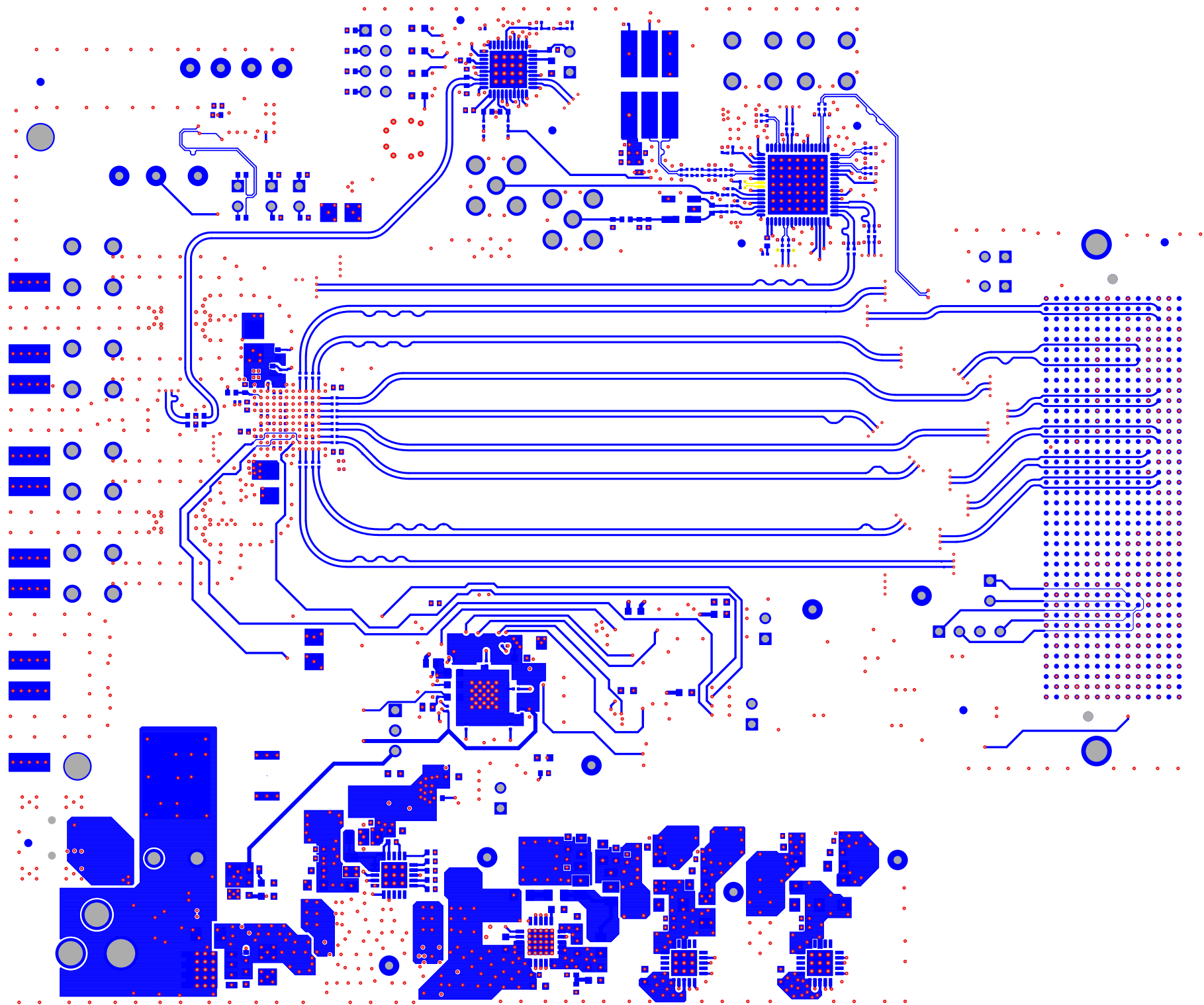
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 10 - SIG-2



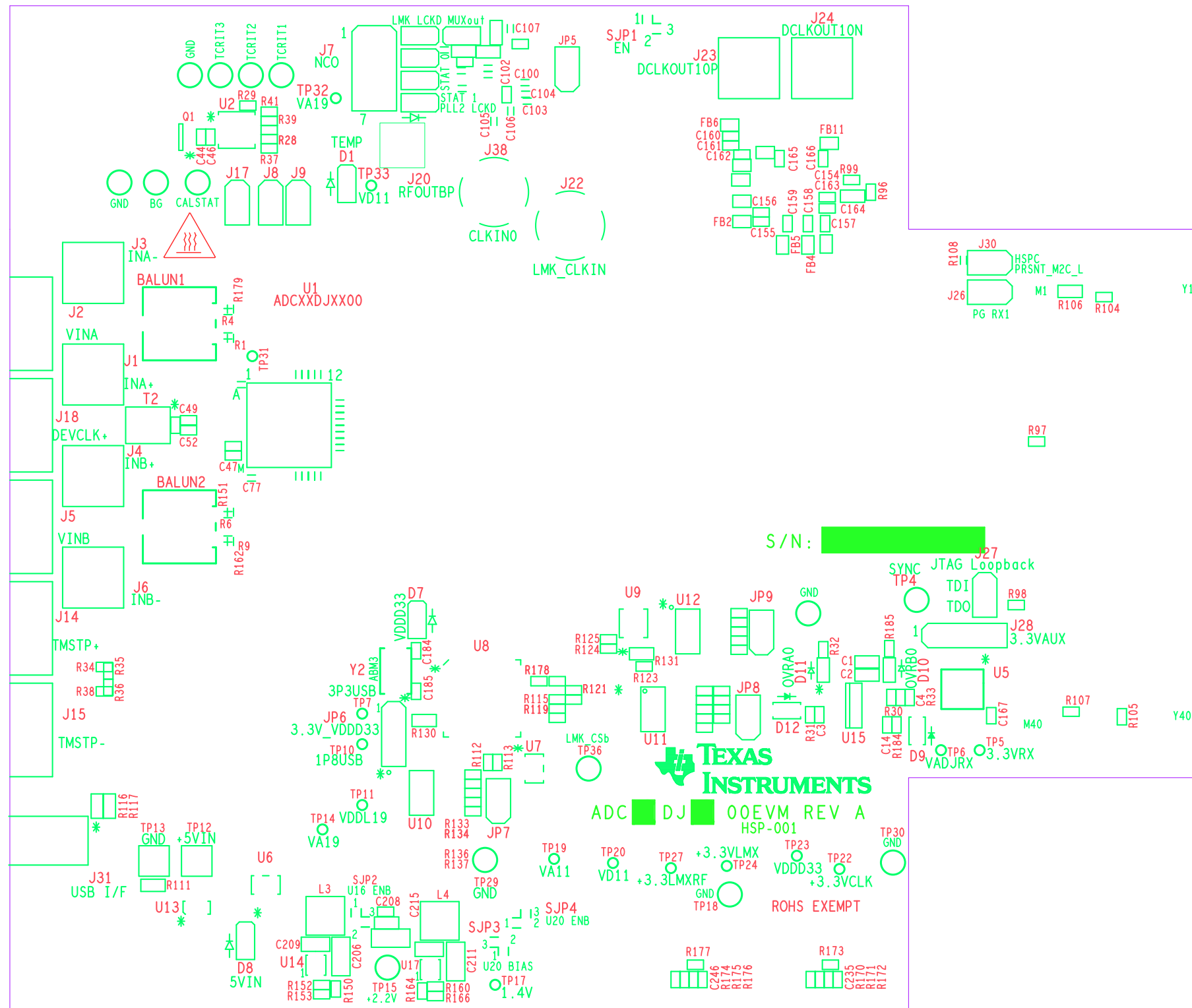
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ADCXXDJXX00EVM REV A
HSP-001

LAYER 11 - GND



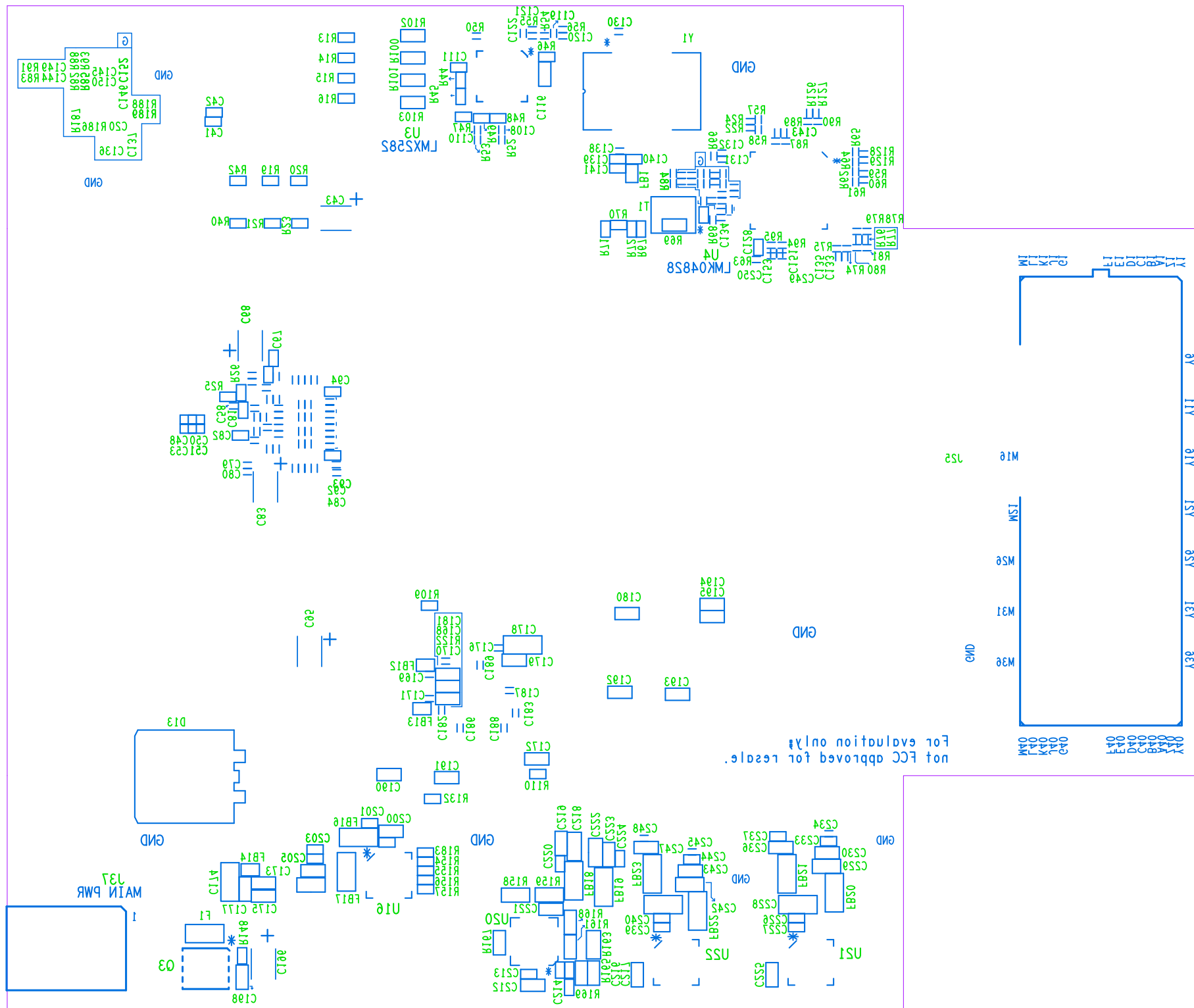
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HSP-001

LAYER 12 (BOTTOM SIDE)



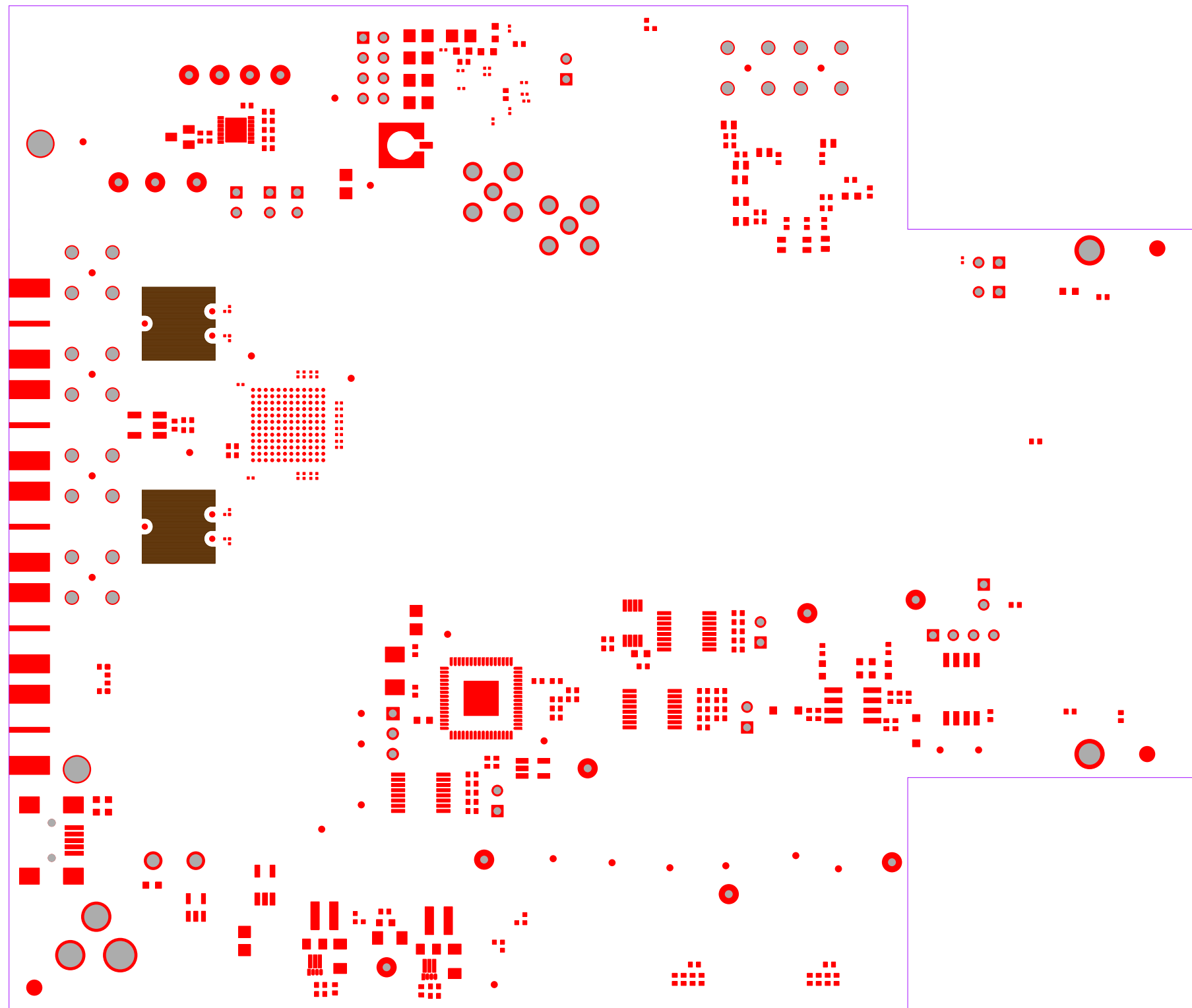
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 ADCXXDJXX00EVM REV A
 HSP-001

SILKSCREEN TOP



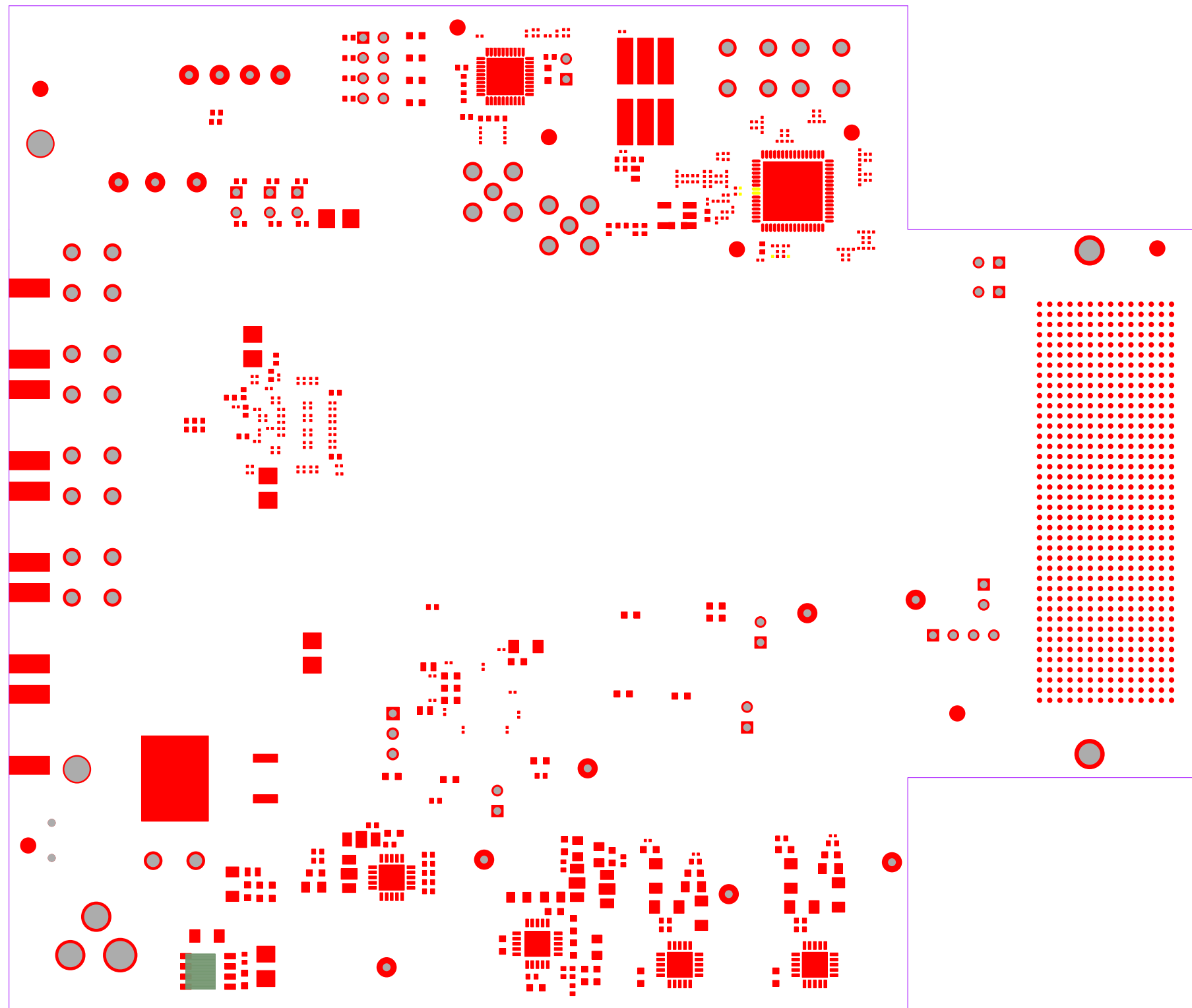
TEXAS INSTRUMENTS, INC.
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HSP-001

SILKSCREEN BOTTOM



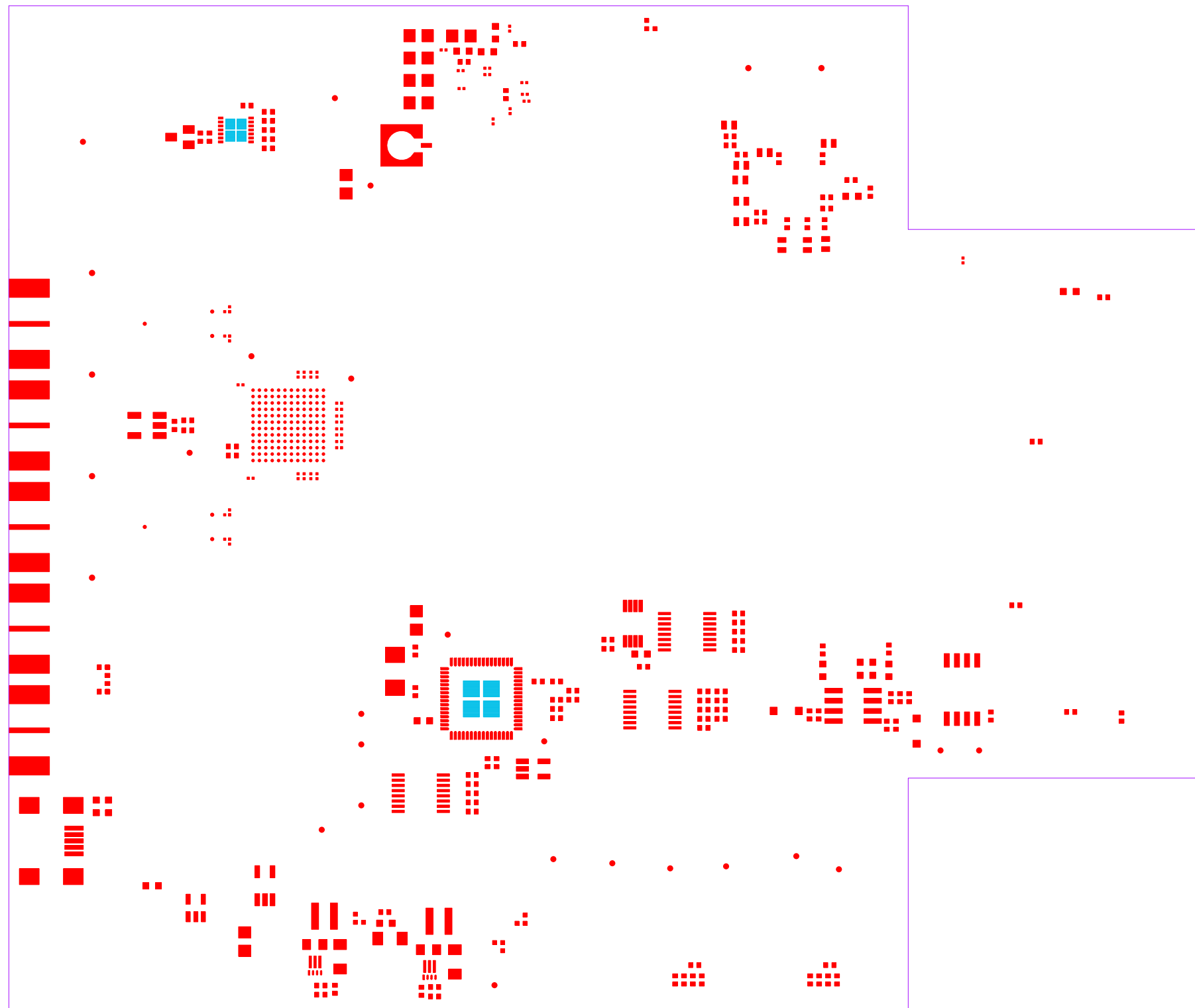
TEXAS INSTRUMENTS, INC.
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HSP-001

SOLDERMASK TOP



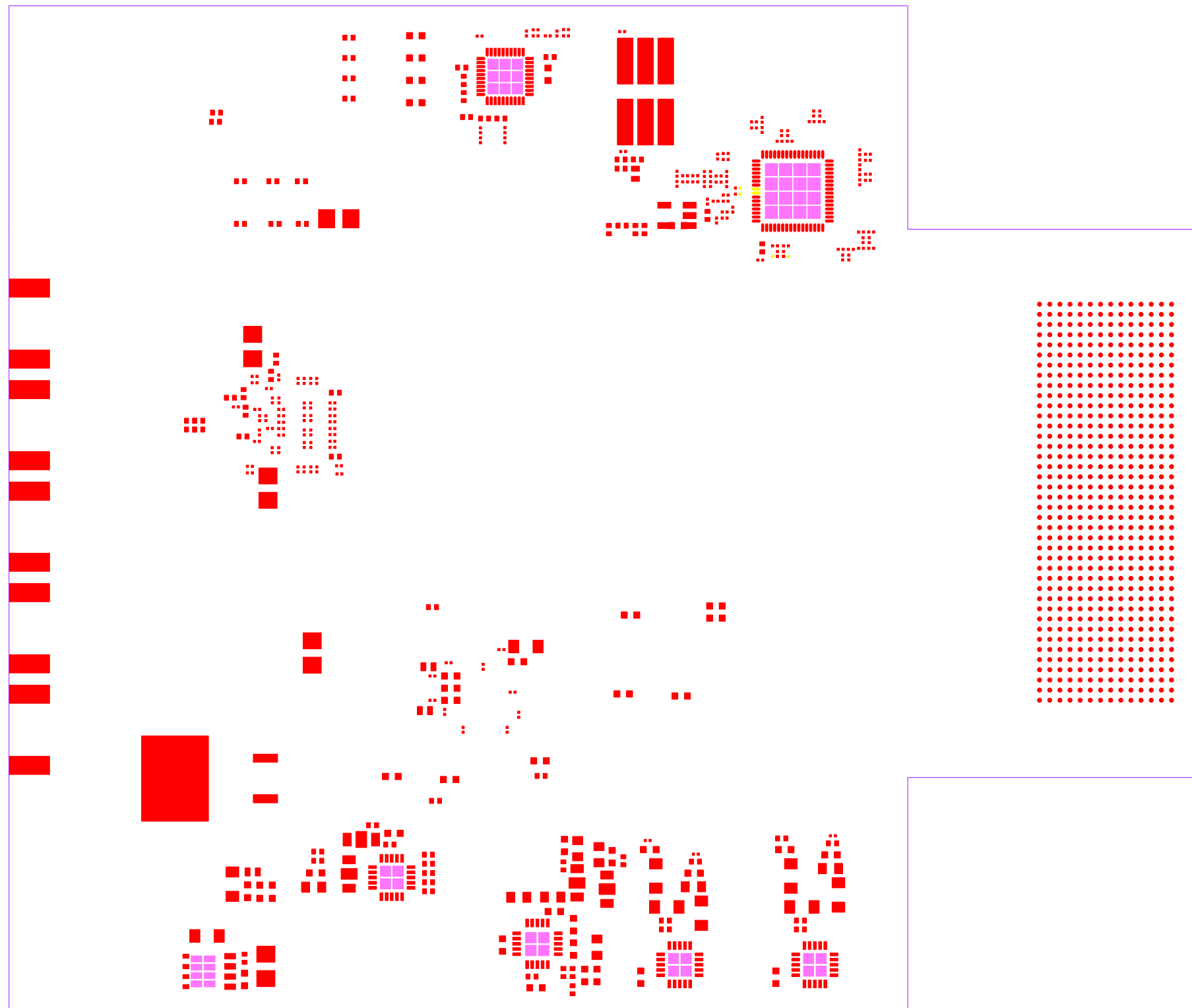
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HSP-001

SOLDERMASK BOTTOM



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PASTEMASK TOP



TEXAS INSTRUMENTS, INC.
ADCXXDJXX00EVM REV A
HSP-001

PASTEMASK BOTTOM

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